FAIRCHILD SEMICONDUCTOR® FDMA7672 Single N-Channel PowerTrench <sup>®</sup> I	April 2012
<ul> <li>30 V, 9 A, 21 mΩ</li> <li>Features</li> <li>Max r<sub>DS(on)</sub> = 21 mΩ at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 9 A</li> <li>Max r<sub>DS(on)</sub> = 32 mΩ at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 7 A</li> <li>Low Profile - 0.8 mm maximum - in the new package MicroFET 2x2 mm</li> <li>Free from halogenated compounds and antimony oxides</li> <li>RoHS compliant</li> </ul>	<ul> <li>General Description</li> <li>This device has been designed to provide maximum efficiency and thermal performance for synchronous buck converters. The low r<sub>DS(on)</sub> and gate charge provide excellent switching performance.</li> <li>Application</li> <li>DC – DC Buck Converters</li> </ul>
Pin 1 D D G Drain D D S D D S MicroFET 2X2 (Bottom View)	D D D D C C C C C C C C C C C C C C C C

# **MOSFET Maximum Ratings** $T_A = 25 \ ^{\circ}C$ unless otherwise noted

Symbol		Parameter		Ratings	Units	
V <sub>DSS</sub>	Drain to Source Voltage			30	V	
V <sub>GSS</sub>	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	9	٨	
D	-Pulsed			24	A	
Р	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.4	w	
PD	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1b)	0.9	VV	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Te	emperature Range		-55 to +150	°C	

### **Thermal Characteristics**

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	6.9	
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (Note 1	a) 52	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (Note 1	b) 145	

## Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
672	FDMA7672	MicroFET 2x2	7 "	12 mm	3000 units

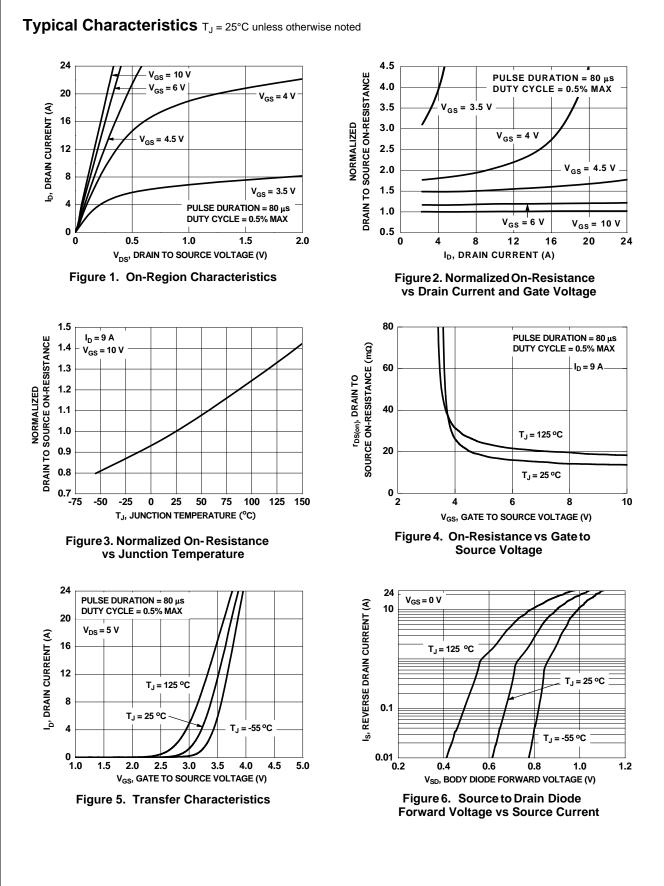
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<sup>®</sup> MOSFET

	Parameter	Test Conditi	ons	Min	Тур	Max	Units
Off Chara	acteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	,	30			V
ΔBV <sub>DSS</sub> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu A$ , reference			16		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$				1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$	1			100	nA
On Chara	acteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu$	A	1.0	2.1	3.0	V
$\Delta V_{GS(th)}$ $\Delta T_J$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C			-6		mV/°C
		$V_{GS} = 10 \text{ V}, I_{D} = 9 \text{ A}$		14	21		
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, \ I_D = 7 \text{ A}$		20	32	mΩ	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 9 A, 1		19	28		
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 9 A			35		S
Dynamic	Characteristics						
C <sub>iss</sub>	Input Capacitance				570	760	pF
C <sub>oss</sub>	Output Capacitance	→ V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V - f = 1.0 MHz			195	260	pF
C <sub>rss</sub>	Reverse Transfer Capacitance				25	40	pF
R <sub>g</sub>	Gate Resistance				1.5		Ω
Switching	g Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time				6	12	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 15 V, I <sub>D</sub> = 9 A	-		2	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$			14	25	ns
t <sub>f</sub>	Fall Time		-		2	10	ns
Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V			9.3	13	nC
Q <sub>g</sub>	Total Gate Charge		√ <sub>DD</sub> = 15 V,		4.4	6	nC
Q <sub>gs</sub>	Gate to Source Gate Charge		I <sub>D</sub> = 9 A		1.9		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge				1.5		nC
Drain-So	urce Diode Characteristics						
I <sub>S</sub>	Maximum Continuous Drain-Source Diod	e Forward Current				2	A
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 2 A$	(Note 2)		0.8	1.2	V
- 30	Reverse Recovery Time		, ,		18	32	ns
t <sub>rr</sub>	Reverse Recovery Charge	- I <sub>F</sub> = 9 A, di/dt = 100 A/μs			5	10	nC

2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0%.

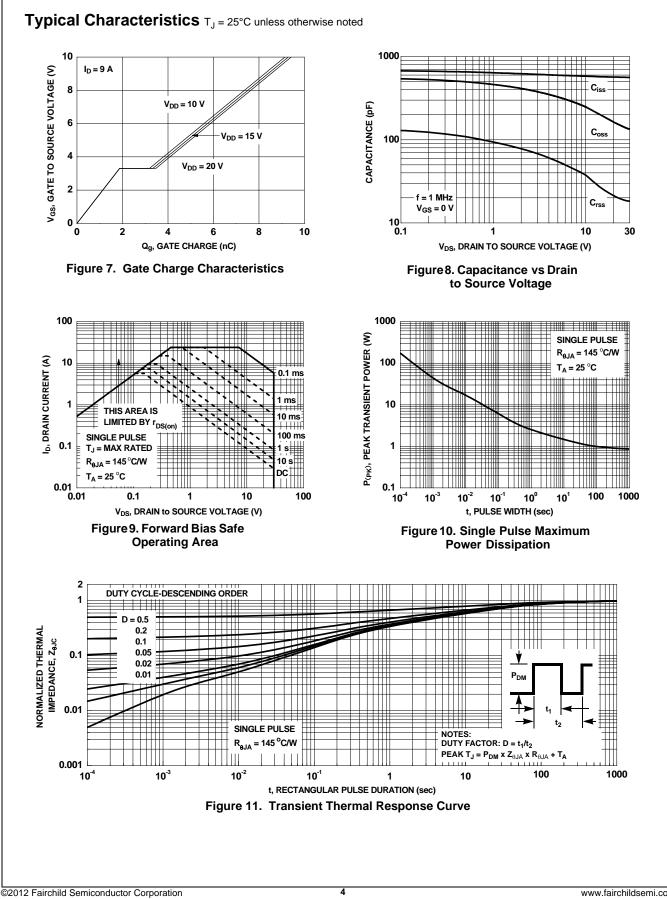
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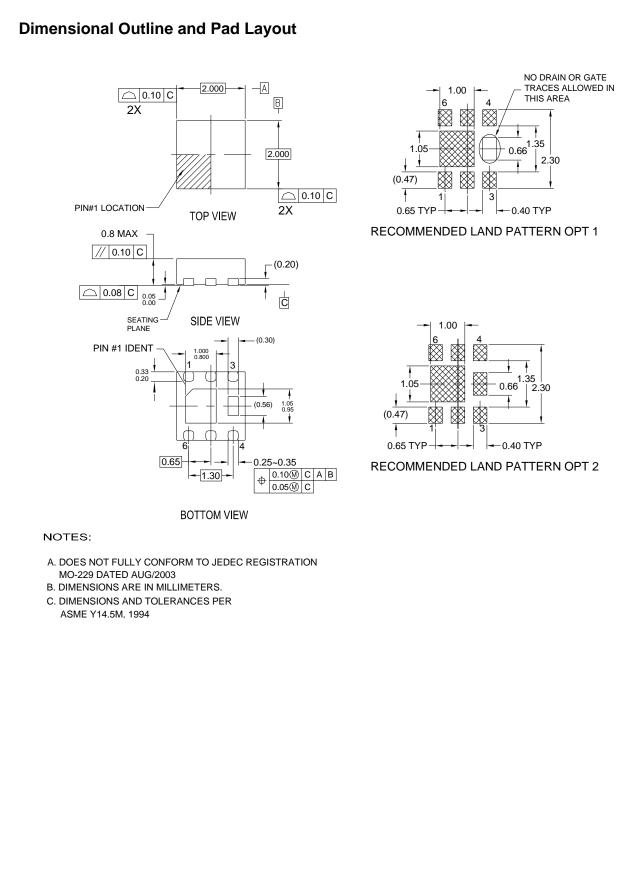
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